Power MOSFET 60V, 80mΩ, 3A, Dual N-Channel

This Power MOSFET is produced using ON Semiconductor's trench technology, which is specifically designed to minimize gate charge and low on resistance. This device is suitable for applications with low gate charge driving or low on resistance requirements.

Features

- Low On-Resistance
- 4V drive
- Low-Profile Package
- ESD Diode-Protected Gate
- Pb-Free and RoHS compliance
- Halogen Free compliance: VEC2415-TL-W

Typical Applications

- Motor Driver
- DC/DC Converter

SPECIFICATIONS

ABSOLUTE MAXIMUM RATING at Ta = 25°C (Note 1)

Parameter	Symbol	Value	Unit
Drain to Source Voltage	VDSS	60	V
Gate to Source Voltage	VGSS	±20	V
Drain Current (DC)	ID	3	Α
Drain Current (Pulse) PW ≤ 10µs, duty cycle ≤ 1%	IDP	12	Α
Power Dissipation When mounted on ceramic substrate (900mm² × 0.8mm) 1unit	PD	0.9	W
Total Dissipation When mounted on ceramic substrate (900mm² × 0.8mm)	PŢ	1.0	w
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg	-55 to +150	°C

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit		
Junction to Ambient When mounted on ceramic substrate (900mm² × 0.8mm) 1unit	$R_{ heta}$ JA	138.8	°C/W		

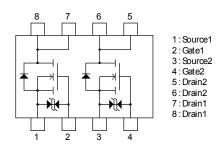


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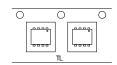
www.onsemi.com

V _{DSS}	R _{DS} (on) Max	I _{D Max}
	80mΩ@ 10V	
60V	106mΩ@ 4.5V	3A
	116mΩ@ 4V	

ELECTRICAL CONNECTION N-Channel



PACKING TYPE : TL MARKING





ORDERING INFORMATION

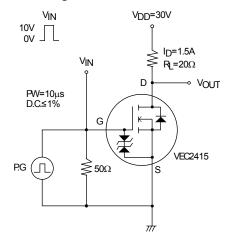
See detailed ordering and shipping information on page 5 of this data sheet.

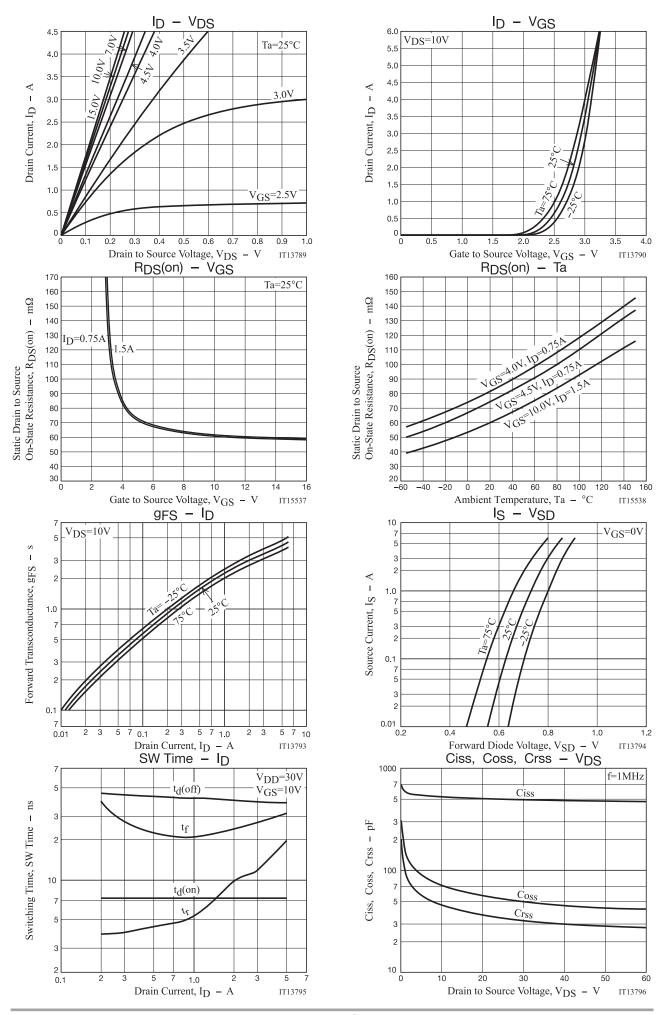
ELECTRICAL CHARACTERISTICS at Ta = 25°C (Note 2)

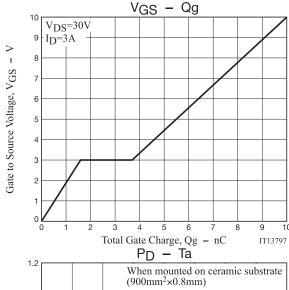
Parameter	Cumbal	Conditions	Value			Unit
Parameter	Symbol	Conditions	min	typ	max	Offic
Drain to Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	60			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =60V, V _{GS} =0V			1	μΑ
Gate to Source Leakage Current	IGSS	V _{GS} =±16V, V _{DS} =0V			±10	μА
Gate Threshold Voltage	V _G S(th)	V _{DS} =10V, I _D =1mA	1.2		2.6	V
Forward Transconductance	gFS	V _{DS} =10V, I _D =1.5A		2.6		S
Static Drain to Source On-State Resistance	R _{DS} (on)1	I _D =1.5A, V _{GS} =10V		62	80	mΩ
	R _{DS} (on)2	I _D =0.75A, V _G S=4.5V		76	106	mΩ
	R _{DS} (on)3	I _D =0.75A, V _{GS} =4V		83	116	mΩ
Input Capacitance	Ciss			505		pF
Output Capacitance	Coss	V _{DS} =20V, f=1MHz		57		pF
Reverse Transfer Capacitance	Crss			37		pF
Turn-ON Delay Time	t _d (on)			7.3		ns
Rise Time	tr	Can appoint Toot Circuit		7.5		ns
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit		41		ns
Fall Time	tf			22		ns
Total Gate Charge	Qg			10		nC
Gate to Source Charge	Qgs	V _{DS} =30V, V _{GS} =10V, I _D =3A		1.6		nC
Gate to Drain "Miller" Charge	Qgd			2.1		nC
Forward Diode Voltage	V _{SD}	IS=3A, VGS=0V		0.81	1.2	V

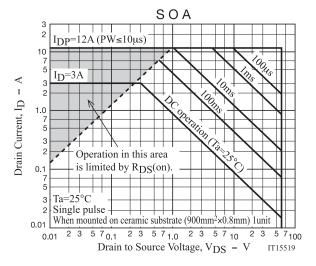
Note 2 : Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

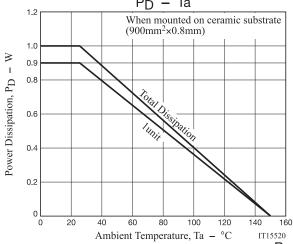
Switching Time Test Circuit

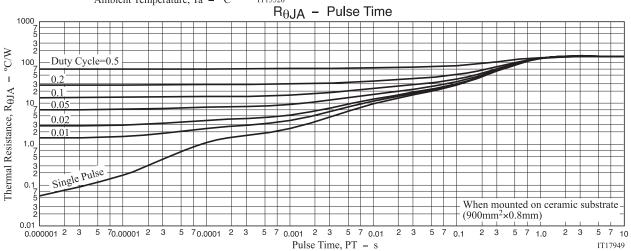






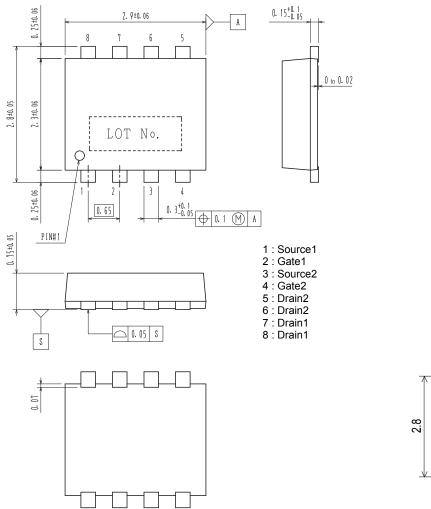




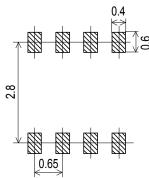


PACKAGE DIMENSIONS

unit: mm SOT-28FL/VEC8 CASE 318AH ISSUE O



Recommended Soldering Footprint



ORDERING INFORMATION

Device	Marking	Package	Shipping (Qty / Packing)	
VEC2415-TL-E	UN	SOT-28FL / VEC8 (Pb-Free)	2.000 / Tara 8 Dayl	
VEC2415-TL-W		SOT-28FL / VEC8 (Pb-Free / Halogen Free)	3,000 / Tape & Reel	

[†] For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. http://www.onsemi.com/pub_link/Collateral/BRD8011-D.PDF

Note on usage: Since the VEC2415 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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